## SUP45P03-09



**Vishay Siliconix** 

# P-Channel 30 V (D-S) MOSFET

PRODUCT	SUMMARY		
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω) MAX.	I <sub>D</sub> (A) <sup>d</sup>	Q <sub>g</sub> (TYP.)
-30	0.0087 at V <sub>GS</sub> = -10 V	-45	60
-30	0.0150 at $V_{GS}$ = -4.5 V	-45	00

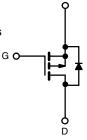


#### **FEATURES**

- TrenchFET<sup>®</sup> power MOSFET
- 100 % R<sub>g</sub> and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### APPLICATIONS

- Power switch
- Load switch in high current applications
- DC/DC converters
- DC/DC conventers



**RoHS** COMPLIANT

HALOGEN

FREE

S

P-Channel MOSFET

#### **Ordering Information:**

SUP45P03-09-GE3 (lead (Pb)-free and halogen-free)

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_c = 25 \degree C$ , unless otherwise noted)						
PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-Source Voltage		V <sub>DS</sub>	-30	N		
Gate-Source Voltage		V <sub>GS</sub>	± 20	V		
Continuous Drain Current (T <sub>1</sub> = 150 °C) <sup>d</sup>	T <sub>C</sub> = 25 °C	- I <sub>D</sub>	-45			
Continuous Drain Current (1j = 150°C) °	T <sub>C</sub> = 70 °C		-45			
Pulsed Drain Current (t = 100 µs)		I <sub>DM</sub>	-100	A		
Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	-35			
Single Avalanche Energy <sup>a</sup>		E <sub>AS</sub>	61	mJ		
Maximum Power Dissipation <sup>a</sup>	T <sub>C</sub> = 25 °C	PD	73.5 <sup>b</sup>	W		
	T <sub>A</sub> = 25 °C °	ГD	3.1	vv		
Operating Junction and Storage Temperature Ran	ge	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C		

THERMAL RESISTANCE RATINGS			
PARAMETER	SYMBOL	LIMIT	UNIT
Junction-to-Ambient (PCB Mount) <sup>c</sup>	R <sub>thJA</sub>	40	°C/W
Junction-to-Case (Drain)	R <sub>thJC</sub>	1.7	0/10

#### Notes

- a. Duty cycle  $\leq$  1 %.
- b. See SOA curve for voltage derating.
- c. When mounted on 1" square PCB (FR4 material).
- d. Package limited.

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$	-30	-	-	V	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = -250 \ \mu A$	-1	-	-2.5	V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	± 250	nA	
		$V_{DS}$ = -30 V, $V_{GS}$ = 0 V	-	-	-1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ = -30 V, $V_{GS}$ = 0 V, $T_{J}$ = 125 °C	-	-	-50	μA	
		$V_{DS}$ = -30 V, $V_{GS}$ = 0 V, $T_{J}$ = 150 $^{\circ}C$	-	-	-250		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \leq$ -10 V, $V_{GS}$ = -10 V	-50	-	-	Α	
Drain-Source On-State Resistance a	Brack	$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -20 \text{ A}$	-	0.0072	0.0087	Ω	
Drain-Source On-State Resistance	purce On-State Resistance <sup>a</sup> R <sub>DS(on)</sub>	$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -15 \text{ A}$	-	0.0125	0.0150	<u>0</u>	
Forward Transconductance <sup>a</sup>	<b>g</b> fs	$V_{DS} = -15 \text{ V}, \text{ I}_{D} = -20 \text{ A}$	-	45	-	S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>		-	2700	-		
Output Capacitance	Coss	$V_{GS} = 0 V, V_{DS} = -15 V, f = 1 MHz$	-	515	-	pF	
Reverse Transfer Capacitance	C <sub>rss</sub>		-	445	-		
Total Gate Charge <sup>c</sup>	Qg		-	60	90		
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -20 \text{ A}$	-	9.3	-	nC	
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>		-	15	-		
Gate Resistance	Rg	f = 1 MHz	0.5	2.5	5	Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>		-	12	20		
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD} = -15 \text{ V}, \text{ R}_{\text{I}} = 1.5 \Omega$	-	11	20		
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong -10$ Å, $V_{GEN} = -10$ V, $R_g = 1$ $\Omega$	-	40	60	ns	
Fall Time <sup>c</sup>	t <sub>f</sub>		-	12	20		
Drain-Source Body Diode Ratings a	nd Characteri	stics <sup>b</sup> (T <sub>C</sub> = 25 °C)					
Continuous Current	Is		-	-	-45		
Pulsed Current (t = 100 µs)	I <sub>SM</sub>		-	-	-100	A	
Forward Voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>F</sub> = -10 A, V <sub>GS</sub> = 0 V	-	-0.8	-1.5	V	
Reverse Recovery Time	t <sub>rr</sub>		-	27	40	ns	
Peak Reverse Recovery Current	I <sub>RM(REC)</sub>	I <sub>F</sub> = -10 A, dl/dt = 100 A/μs	-	1.3	2	А	
Reverse Recovery Charge	Q <sub>rr</sub>		-	20	30	nC	

Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

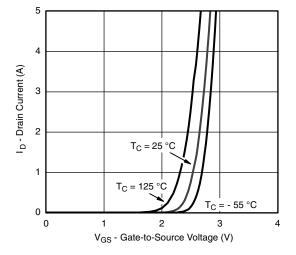
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2

0.000 2.5 1.0 1.5 2.0 0 20 V<sub>DS</sub> - Drain-to-Source Voltage (V) **Output Characteristics** 

0.020



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100

80

40

20

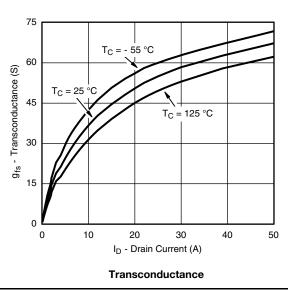
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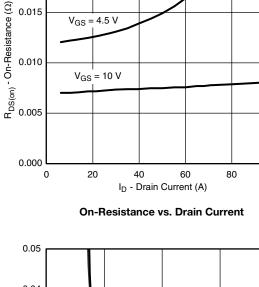
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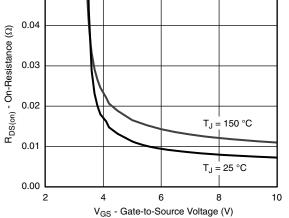
0.5

I<sub>D</sub> - Drain Current (A) 60

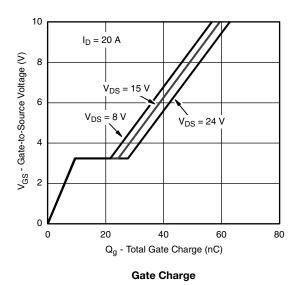












TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

 $V_{GS} = 10 \text{ V}$  thru 5 V

V<sub>GS</sub> = 4 V

 $V_{GS} = 3 V$ 

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100

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S15-1158-Rev. A, 18-May-15

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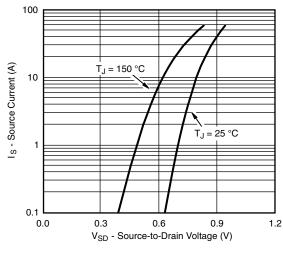
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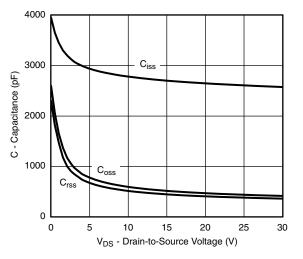
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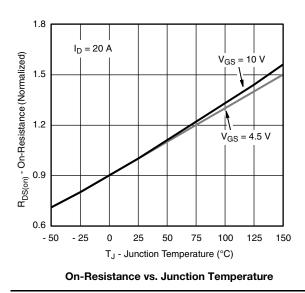
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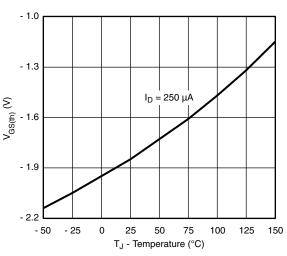


Source-Drain Diode Forward Voltage

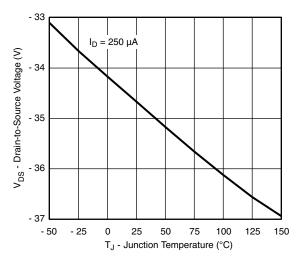




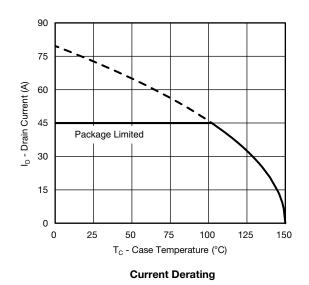




Threshold Voltage



Drain Source Breakdown vs. Junction Temperature



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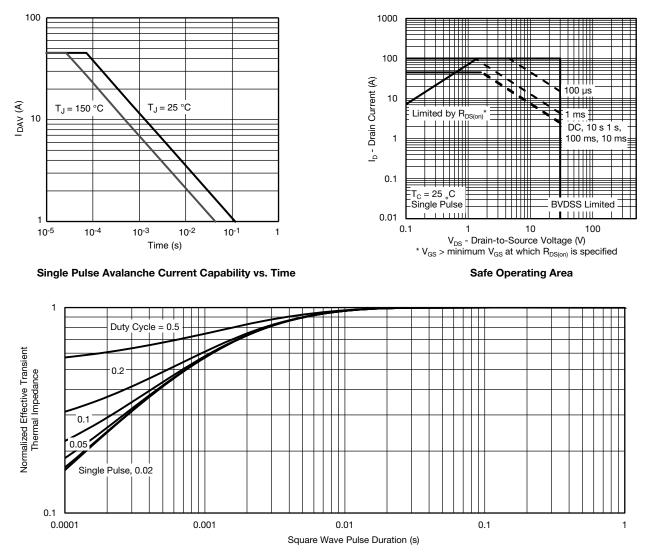
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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

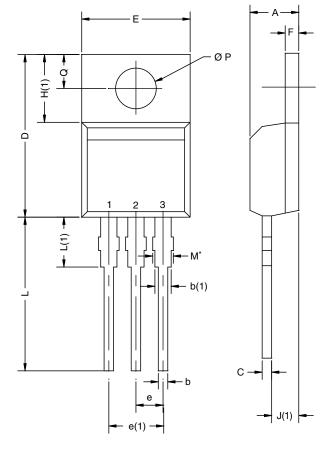
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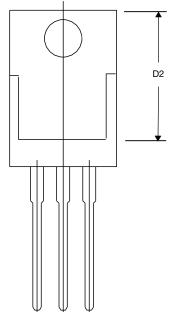
# **TO-220AB**



	MILLIN	MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
с	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
D2	12.19	12.70	0.480	0.500	
Е	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØΡ	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	
ECN: T14- DWG: 547	0413-Rev. P, 1	16-Jun-14			

### Note

\* M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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